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RoHS

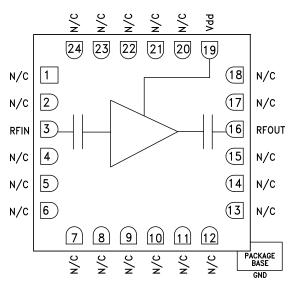
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Typical Applications

The HMC383LC4 is ideal for:

- Point-to-Point Radios
- Point-to-Multi-Point Radios & VSAT
- Test Equipment & Sensors
- LO Driver for HMC Mixers
- Military & Space

Functional Diagram



GaAs PHEMT MMIC MEDIUM POWER AMPLIFIER, 12 - 30 GHz

HMC383LC4

Features

Gain: 15 dB Saturated Output Power: +18 dBm Output IP3: +25 dBm Single Positive Supply: +5V @ 100 mA 50 Ohm Matched Input/Output RoHS Compliant 4x4 mm Package

General Description

The HMC383LC4 is a general purpose GaAs PHEMT MMIC Driver Amplifier housed in a leadless RoHS compliant SMT package. The amplifier provides 15 dB of gain and +18 dBm of saturated power from a single +5V supply. Consistent gain and output power across the operating band make it possible to use a common driver/LO amplifier approach in multiple radio bands. The RF I/Os are DC blocked and matched to 50 Ohms for ease of use. The HMC383LC4 is housed in a RoHS compliant leadless 4x4 mm package allowing the use of surface mount manufacturing techniques.

Electrical Specifications, $T_{A} = +25^{\circ} C$, Vdd = +5V

Parameter	Min.	Тур.	Max.	Min.	Тур.	Max.	Min.	Тур.	Max.	Min.	Тур.	Max.	Units
Frequency Range		12 - 16			16 -24			24 - 28			28 - 30		GHz
Gain	12	15		13	16		12	15		10	13		dB
Gain Variation Over Temperature		0.02	0.03		0.02	0.03		0.02	0.03		0.02	0.03	dB/ °C
Input Return Loss		14			14			11			13		dB
Output Return Loss		14			17			10			8		dB
Output Power for 1 dB Compression (P1dB)	12	15		13.5	16.5		13	16		12	15		dBm
Saturated Output Power (Psat)		17			18			17			16		dBm
Output Third Order Intercept (IP3)		24			25			25			23		dBm
Noise Figure		10.5			8			7.5			8		dB
Supply Current (Idd)	75	100	135	75	100	135	75	100	135	75	100	135	mA

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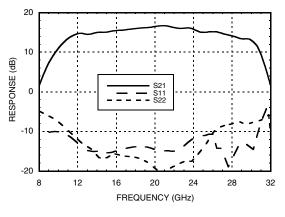
GaAs PHEMT MMIC MEDIUM

POWER AMPLIFIER, 12 - 30 GHz

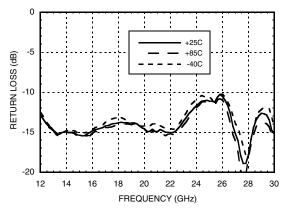
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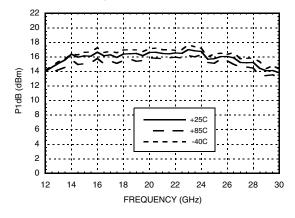
Broadband Gain & Return Loss



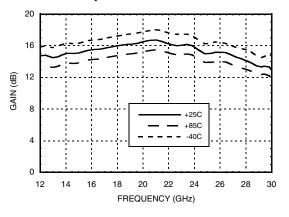
Input Return Loss vs. Temperature



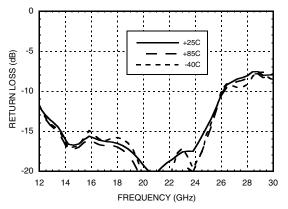
P1dB vs. Temperature



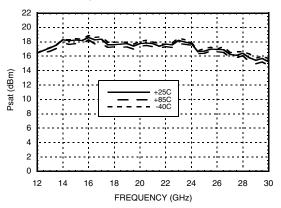
Gain vs. Temperature



Output Return Loss vs. Temperature



Psat vs. Temperature



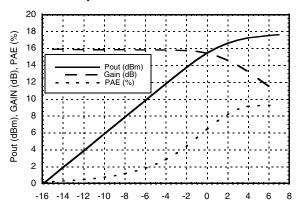
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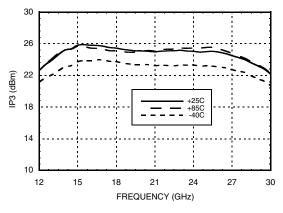
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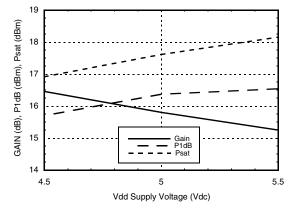
Power Compression @ 18 GHz



Output IP3 vs. Temperature

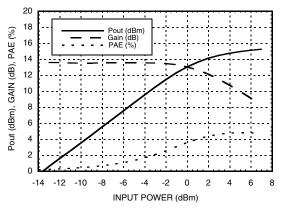


Gain & Power vs. Supply Voltage @ 18 GHz

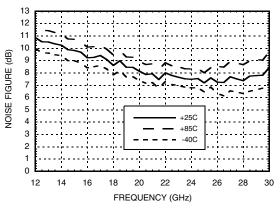


GaAs PHEMT MMIC MEDIUM POWER AMPLIFIER, 12 - 30 GHz

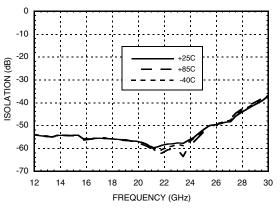
Power Compression @ 30 GHz



Noise Figure vs. Temperature



Reverse Isolation vs. Temperature



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Absolute Maximum Ratings

Drain Bias Voltage (Vdd)	+5.5 Vdc		
,			
RF Input Power (RFIN)(Vdd = +5Vdc)	+10 dBm		
Channel Temperature	175 °C		
Continuous Pdiss (T= 85 °C) (derate 10 mW/°C above 85 °C)	0.92 W		
Thermal Resistance (channel to ground paddle)	98 °C/W		
Storage Temperature	-65 to +150 °C		
Operating Temperature	-40 to +85 °C		
ESD Sensitivity (HBM)	Class 1A		

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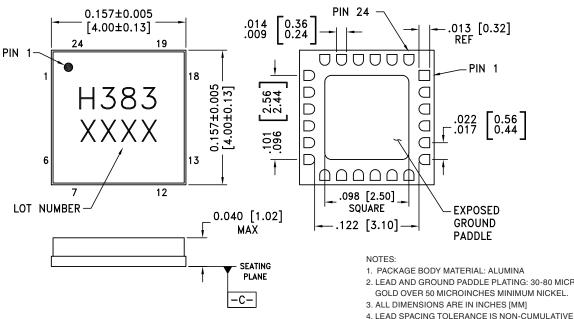
Typical Supply Current vs. Vdd

Vdd (V)	ldd (mA)
+4.5	99
+5.0	100
+5.5	101

Note: Amplifier will operate over full voltage ranges shown above



Outline Drawing



BOTTOM VIEW

- 2. LEAD AND GROUND PADDLE PLATING: 30-80 MICROINCHES
- 5. PACKAGE WARP SHALL NOT EXCEED 0.05mm DATUM -C-
- 6. ALL GROUND LEADS AND GROUND PADDLE MUST BE SOLDERED TO PCB RF GROUND

Package Information

Part Number	Package Body Material	Lead Finish	MSL Rating	Package Marking [2]
HMC383LC4	Alumina, White	Gold over Nickel	MSL3 ^[1]	H383 XXXX

[1] Max peak reflow temperature of 260 °C

[2] 4-Digit lot number XXXX

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HMC383LC4



GaAs PHEMT MMIC MEDIUM POWER AMPLIFIER, 12 - 30 GHz

Pin Descriptions

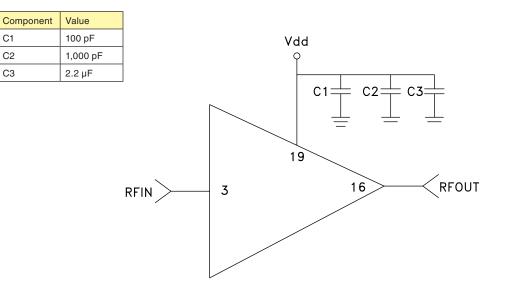
Pin Number	Function	Description	Interface Schematic
1, 2, 4 - 15, 17, 18, 20 - 24	N/C	No connection required. These pins may be connected to RF/DC ground without affecting performance if using grounded coplanar wave guide transmission lines.	
3	RFIN	This pad is AC coupled and matched to 50 Ohms.	RFINO
16	RFOUT	This pad is AC coupled and matched to 50 Ohms.	
19	Vdd	Power Supply Voltage for the amplifier. External bypass capacitors of 100 pF, 1,000 pF and 2.2 μF are required.	⊖Vdd _ =
	GND	Package base has an exposed metal ground that must be connected to RF/DC ground. Vias under the device are required	

Application Circuit

C1

C2

C3



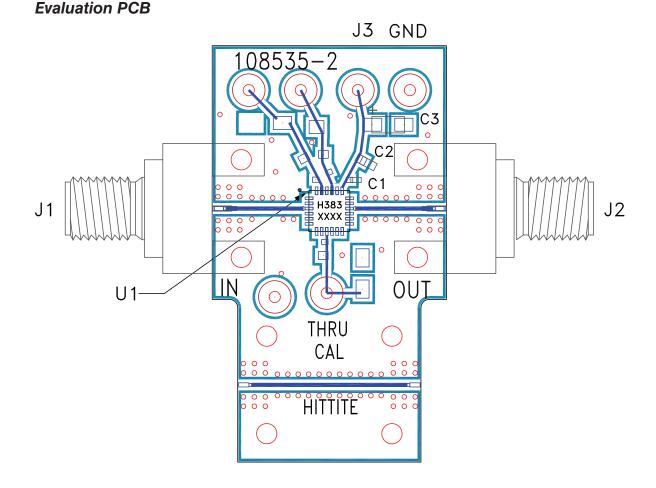
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GaAs PHEMT MMIC MEDIUM POWER AMPLIFIER, 12 - 30 GHz



List of Materials for Evaluation PCB 122198 [1]

Item	Description		
J1, J2	2.92 mm PCB mount K-connector		
J3, J4	DC Pin		
C1	100 pF capacitor, 0402 pkg.		
C2	1,000 pF Capacitor, 0603 pkg.		
C3	2.2µF Capacitor, Tantalum		
U1	HMC383LC4 Amplifier		
PCB [2]	108535 Evaluation PCB		

[1] Reference this number when ordering complete evaluation PCB

[2] Circuit Board Material: Rogers 4350.

The circuit board used in this application should use RF circuit design techniques. Signal lines should have 50 Ohm impedance while the package ground leads and exposed paddle should be connected directly to the ground plane similar to that shown. A sufficient number of via holes should be used to connect the top and bottom ground planes. The evaluation board should be mounted to an appropriate heat sink. The evaluation circuit board shown is available from Hittite upon request.

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